

ON Semiconductor®

FQB5N90

N-Channel QFET® MOSFET

900 V, 5.4 A, 2.3 Ω

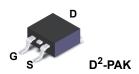
Description

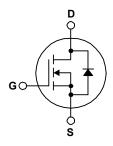
This N-Channel enhancement mode power MOSFET is • Low Gate Charge (Typ. 31 nC) produced using ON Semiconductor's proprietary planar • Low Crss (Typ. 13 pF) stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state • 100% Avalanche Tested resistance, and to provide superior switching performance

• RoHS Compliant and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.

Features

- 5.4 A, 900 V, $R_{DS(on)}$ = 2.3 Ω (Max.) @ V_{GS} = 10 V, $I_D = 2.7 A$





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter		FQB5N90TM	Unit
V _{DSS}	Drain-Source Voltage		900	V
I _D	Drain Current - Continuous (T _C = 25°C)		5.4	А
	- Continuous (T _C = 100°C)		3.42	А
I _{DM}	Drain Current - Pulsed	(Note 1)	21.6	Α
V_{GSS}	Gate-Source Voltage		± 30	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	660	mJ
I _{AR}	Avalanche Current	(Note 1)	5.4	Α
E _{AR}	Repetitive Avalanche Energy	(Note 1)	15.8	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	4.0	V/ns
P_{D}	Power Dissipation (T _A = 25°C) *		3.13	W
	Power Dissipation (T _C = 25°C)		158	W
	- Derate above 25°C		1.27	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
T _L	Maximum lead temperature for soldering, 1/8" from case for 5 seconds		300	°C

Thermal Characteristics

Symbol	Parameter	FQB5N90TM	Unit
R_{\thetaJC}	Thermal Resistance, Junction to Case, Max.	0.79	
В	Thermal Resistance, Junction to Ambient (Minimum Pad of 2-oz Copper), Max.	62.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (*1 in ² Pad of 2-oz Copper), Max.	40	

Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FQB5N90TM	FQB5N90	D ² -PAK	Tape and Reel	330 mm	24 mm	800 units

Electrical Characteristics

T_C = 25°C unless otherwise noted.

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Cha	racteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	900			V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	I_D = 250 μ A, Referenced to 25°C		1.0		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 900 V, V _{GS} = 0 V			10	μΑ
		V _{DS} = 720 V, T _C = 125°C			100	μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 30 V, V _{DS} = 0 V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -30 V, V _{DS} = 0 V			-100	nA
	racteristics Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	3.0		5.0	V
V _{GS(th)}	•	VDS - VGS, ID - 250 μA	3.0		5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	$V_{GS} = 10 \text{ V}, I_D = 2.7 \text{ A}$		1.8	2.3	Ω
9 _{FS}	Forward Transconductance	V _{DS} = 50 V, I _D = 2.7 A		5.6		S

Dynamic Characteristics

C _{iss}	Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V,	 1200	1550	pF
Coss	Output Capacitance	f = 1.0 MHz	 110	145	pF
C _{rss}	Reverse Transfer Capacitance		 13	17	pF

Switching Characteristics

	•				
t _{d(on)}	Turn-On Delay Time	V _{DD} = 450 V, I _D = 5.4 A,	 28	65	ns
t _r	Turn-On Rise Time	$R_G = 25 \Omega$	 65	140	ns
t _{d(off)}	Turn-Off Delay Time		 65	140	ns
t _f	Turn-Off Fall Time	(Note 4	 50	110	ns
Qg	Total Gate Charge	V _{DS} = 720 V, I _D = 5.4 A,	 31	40	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 10 V	 7.2		nC
Q_{gd}	Gate-Drain Charge	(Note 4	 15		nC

Drain-Source Diode Characteristics and Maximum Ratings

I _S	Maximum Continuous Drain-Source Diode Forward Current		 	5.4	Α
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current		 	21.6	Α
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 5.4 A	 	1.4	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _S = 5.4 A,	 610		ns
Q _{rr}	Reverse Recovery Charge	$dI_{F} / dt = 100 A/\mu s$	 5.26		μС

Notes

- ${\it 1. Repetitive\ rating: pulse-width\ limited\ by\ maximum\ junction\ temperature.}$
- 2. L = 43 mH, I_{AS} = 5.4 A, V_{DD} = 50 V, R_{G} = 25 Ω , starting T_{J} = 25°C.
- 3. I $_{SD} \leq$ 5.4 A, di/dt \leq 200 A/ μs , $V_{DD} \leq$ BV $_{DSS,}$ starting $~T_J$ = 25°C.
- ${\bf 4.} \ {\bf Essentially independent of operating \ temperature}.$

Typical Characteristics

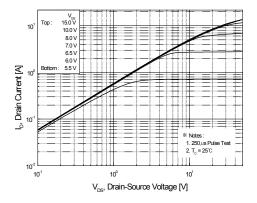


Figure 1. On-Region Characteristics

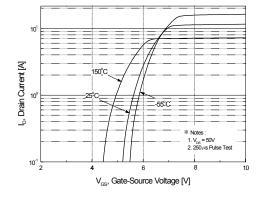


Figure 2. Transfer Characteristics

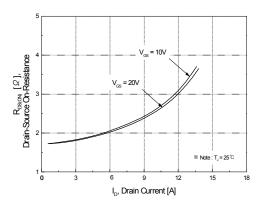


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

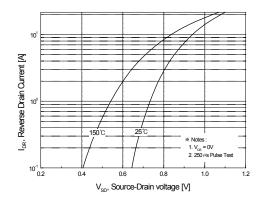


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

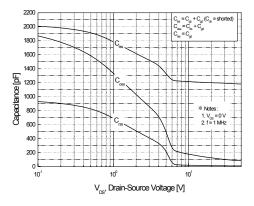


Figure 5. Capacitance Characteristics

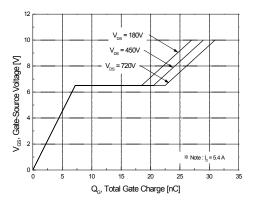
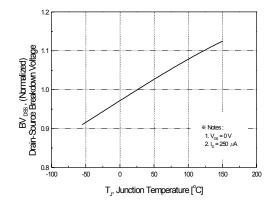


Figure 6. Gate Charge Characteristics

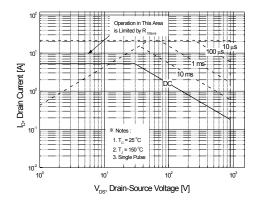
Typical Characteristics (Continued)



3.0

Figure 7. Breakdown Voltage Variation vs. Temperature

Figure 8. On-Resistance Variation vs. Temperature



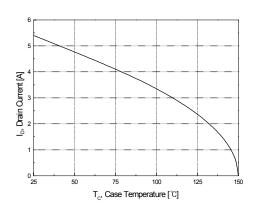


Figure 9. Maximum Safe Operating Area

Figure 10. Maximum Drain Current vs. Case Temperature

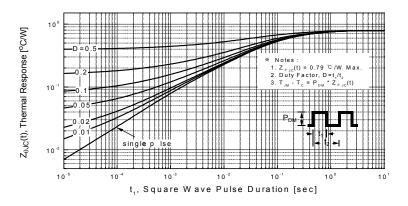


Figure 11. Transient Thermal Response Curve

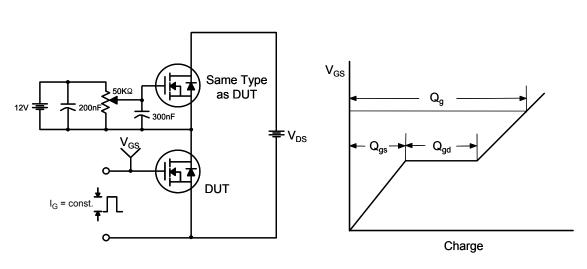


Figure 12. Gate Charge Test Circuit & Waveform

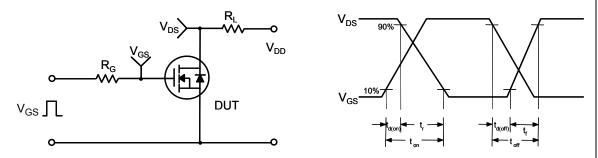


Figure 13. Resistive Switching Test Circuit & Waveforms

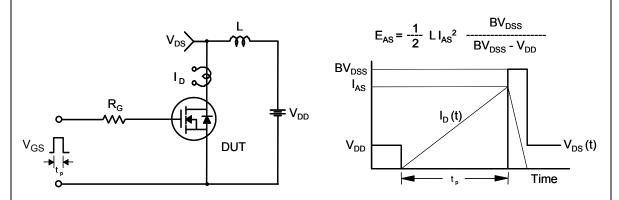


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms

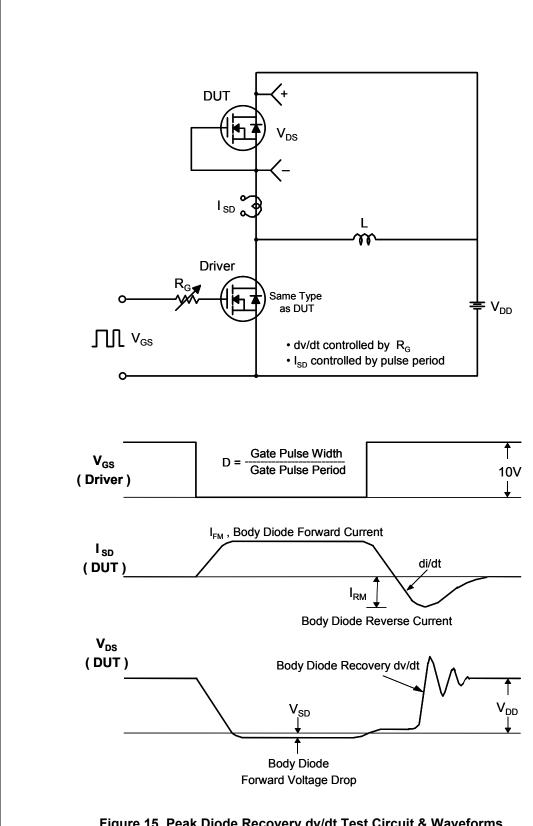


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

Mechanical Dimensions

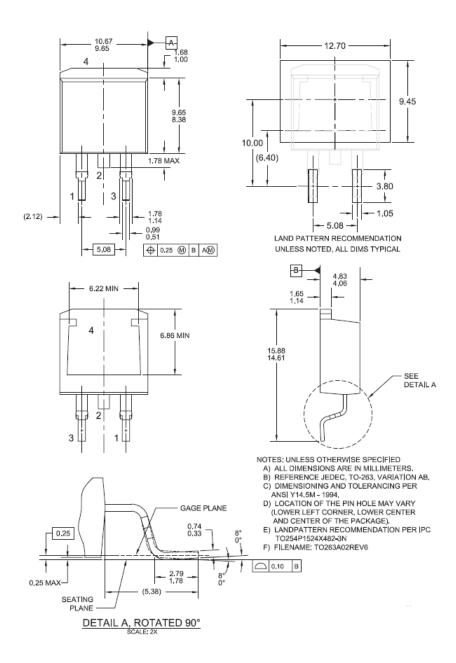


Figure 16. TO263 (D²PAK), Molded, 2-Lead, Surface Mount

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